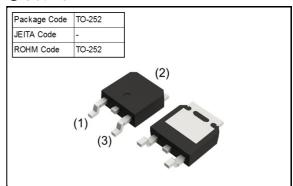


Schottky Barrier Diode

Data sheet

V <sub>R</sub>	30	V
l <sub>o</sub>	10	Α
I <sub>FSM</sub>	50	Α

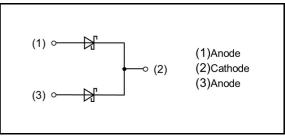
#### Outline



Features

High reliability Power mold type Cathode common dual type Low  $V_{\mathsf{F}}$ 

Inner Circuit



Application

Switching power supply

Packaging Specifications

T deltaging epochications				
Packing	Embossed Tape			
Reel Size(mm) 330				
Taping Width(mm)	16			
Quantity(pcs)	2500			
Taping Code	TL			
Marking	BR10BM30A			

Structure Silicon epitaxial planar

◆ Absolute Maximum Ratings (T<sub>c</sub>=25°C unless otherwise specified)

Parameter	Symbol	Conditions	Limits	Unit
Repetitive peak reverse voltage	$V_{RM}$	Duty≦0.5	30	V
Reverse voltage	V <sub>R</sub>	Reverse direct voltage	30	V
Average rectified forward current	lo	60Hz half sin waveform, resistive load, I <sub>0</sub> /2 per diode, T <sub>c</sub> =100°cMax.	10	Α
Peak forward surge current	I <sub>FSM</sub>	60Hz half sin waveform, non-repetitive, per diode, T <sub>a</sub> =25°c	50	А
Junction temperature <sup>(1)</sup>	Tj	-	150	°C
Storage temperature	T <sub>stg</sub>	-	-55 ~ 150	ဇ

Note(1) To avoid occurrence of thermal runaway, actual board is to be designed to fulfill  $dP_d/dT_i < 1/R_{\theta JA}$ .

#### Attention

Compared with PN junction diodes, Schottky Barrier Diode is generally high reverse current (IR). The reverse loss of the diode might increase as temperature increasing that causes heat-up and further IR. This phenomenon might end up the thermal destruction(thermal runaway). Therefore please give consideration to the reverse loss and the ambient temperature when using this product.

## ● Electrical Characteristics (T<sub>i</sub>=25°C unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward voltage <sup>(1)</sup>	V <sub>F</sub>	I <sub>F</sub> =5A	-	-	0.55	V
Reverse current <sup>(1)</sup>	I <sub>R</sub>	V <sub>R</sub> =30V	-	-	100	μA

Note (1) Value per diode

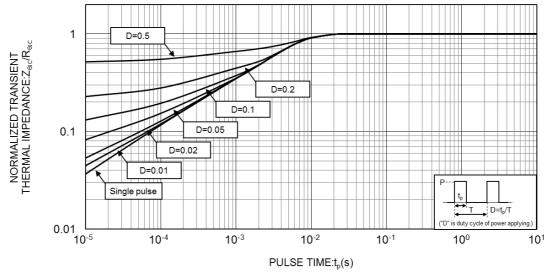
## Thermal Characteristics

Parameter		Symbol	Min.	Тур.	Max.	Unit
Thermal Resistance (Junction to case) <sup>(1) (2)</sup>	Per diode	- R <sub>OJC</sub>	-	•	3.5	°C/W
	Per device		-	-	2.2	°C/W
Thermal Resistance (Junction to ambient) <sup>(1)</sup> (3)		$R_{\theta JA}$	-	-	75	°C/W

Notes (1) Value is guaranteed by design.

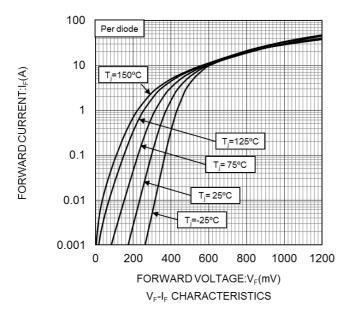
- (2) Transient dual interface measurement (TDIM) method.
- (3) Mounted on 50 x 50 x 1.6mm FR4 board, single-sided copper, 35µm thickness, reference footprint.

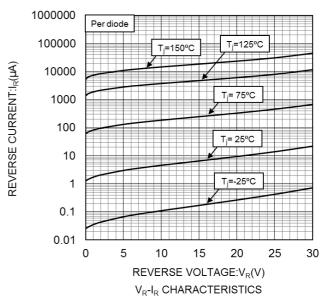
### Characteristic Curves

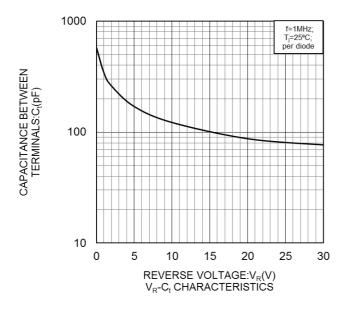


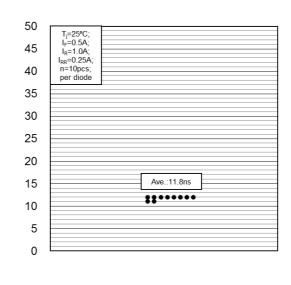
NORMALIZED TRANSIENT THERMAL IMPEDANCE FROM JUNCTION TO CASE (PER DEVICE)

## Characteristic Curves



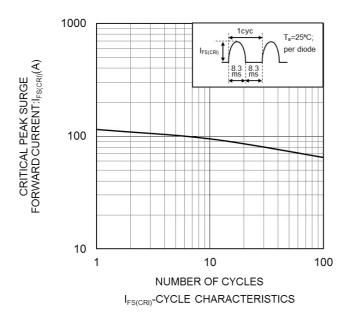


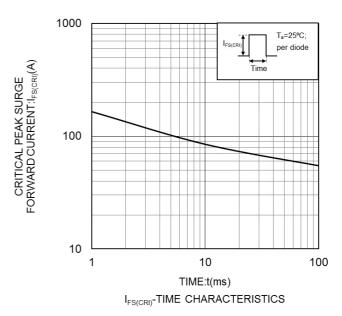


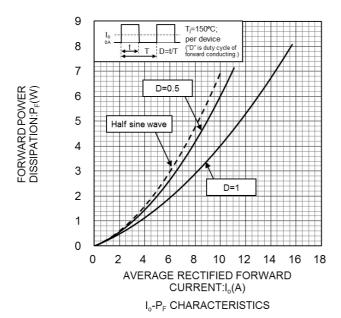


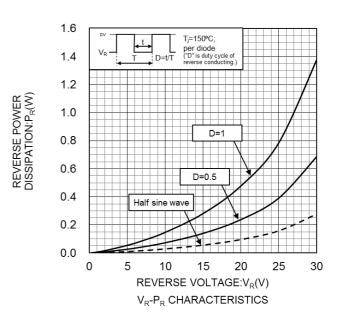
REVERSE RECOVERY TIME:t<sub>rr</sub>(ns)

## Characteristic Curves

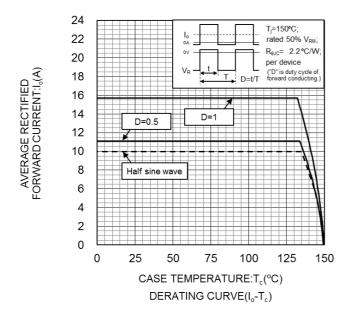




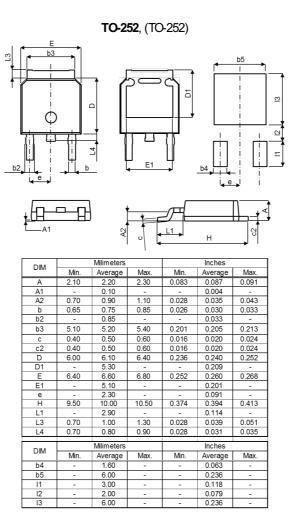




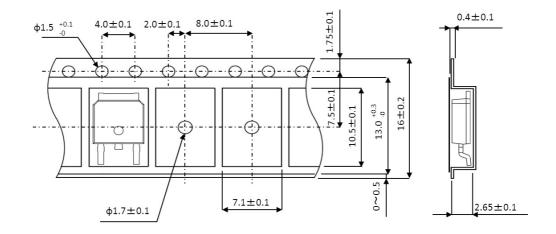
## Characteristic Curves



## Dimensions



## ● Taping (Unit:mm)



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JAPAN	USA	EU	CHINA
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CLASSIV		CLASSⅢ	CLASSⅢ

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  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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For details, please refer to ROHM Mounting specification

#### **Precautions Regarding Application Examples and External Circuits**

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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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Rev.001

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